

MODEL NO: 12-215SYGC/S530-E1/TR8

Device Number : DSE-125-015 REV. 1.0

Chip LEDs with Right Angle Lens

ECN :

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■ Features :

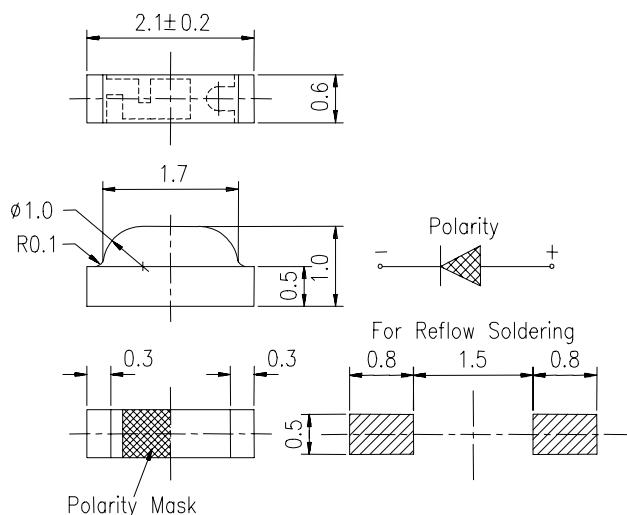
- Package in 8mm tape on 7" diameter reel.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- Mono-color type.

■ Descriptions :

- The 12-215 SMD Taping is much smaller than lead frame type components, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- Besides, lightweight makes them ideal for miniature applications, etc.

■ Applications :

- Automotive: backlighting in dashboard and switch.
- Telecommunication: indicator and backlighting in telephone and fax.
- Flat backlight for LCD, switch and symbol.
- General use.

■ Package Dimensions :**■ Notes :**

Tolerances Unless Dimension \pm
0.1mm
Angle $\pm 0.5^\circ$

PART NO	Chip		Lens Color
	Material	Emitted Color	
12-215SYGC/S530-E1/TR8	AlGaInP	Super Yellow Green	Water Clear

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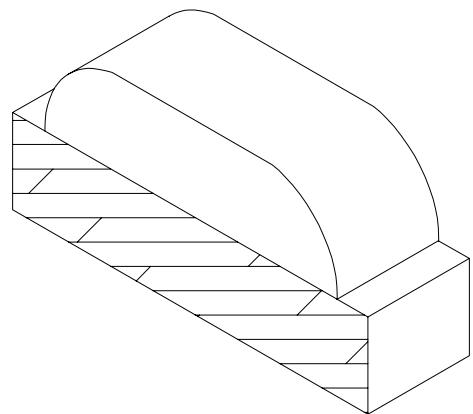
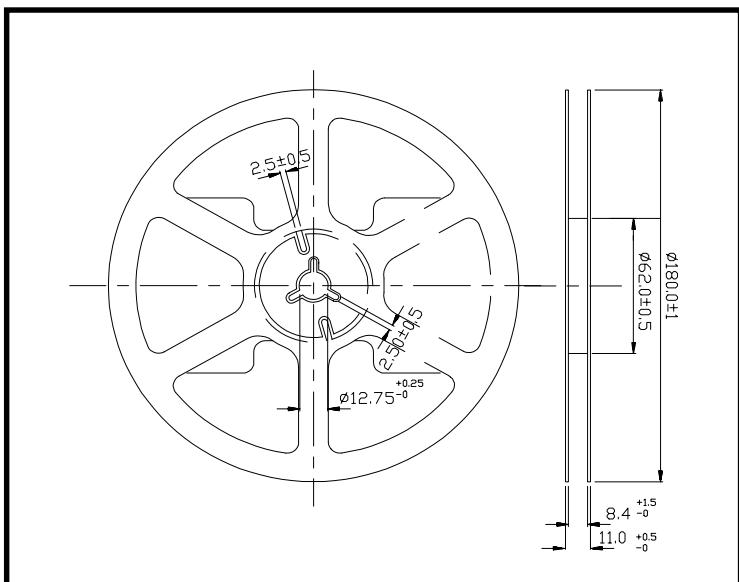
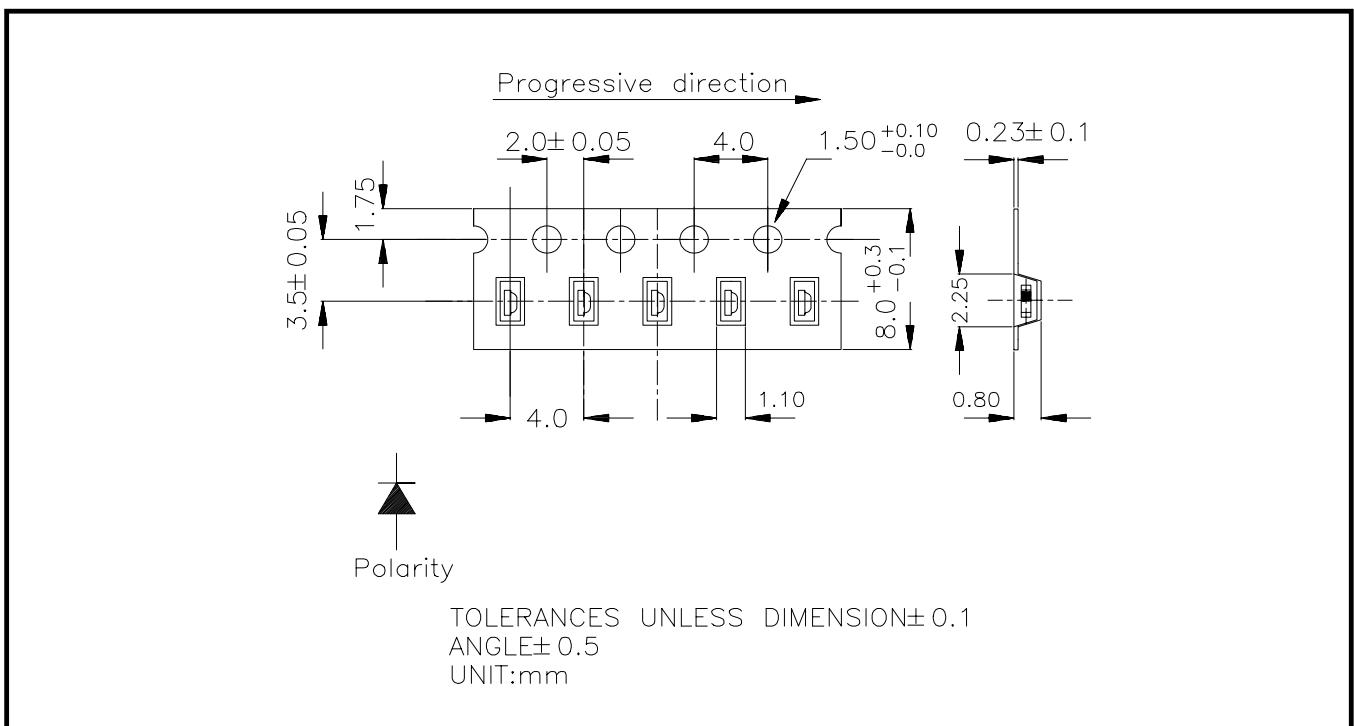
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■ Package Dimensions :**■ Loaded quantity per reel 3000 pcs/reel :**



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Page: 3/8**■ Absolute Maximum Ratings at Ta = 25°C**

Parameter	Symbol	Rating	Unit
Reverse Voltage	Vr	5	V
Forward Current	If	25	mA
Operating Temperature	Topr	-40 ~ +85	°C
Storage Temperature	Tstg	-40 ~ +90	°C
Soldering Temperature	Tsol	260 (for 5 second)	°C
Electrostatic discharge	ESD	2000	V
Power Dissipation	Pd	60	mW
Peak Forward Current(Duty 1/10 @ 1KHZ)	If(Peak)	160	mA

■ Electronic Optical Characteristics :

Parameter	Symbol	Min.	Typ.	Max.	Unit	Condition
Luminous Intensity	Iv	-----	1	-----	mcd	If=2mA
		13	20	-----	mcd	If=20mA
Viewing Angle	2θ 1/2	-----	130	-----	deg	If=20mA
Peak Wavelength	λ p	-----	575	-----	nm	If=20mA
Dominant Wavelength	λ d	-----	573	-----	nm	If=20mA
Spectrum Radiation Bandwidth	△λ	-----	20	-----	nm	If=20mA
Forward Voltage	Vf	-----	2.0	2.4	V	If=20mA
Reverse Current	Ir	-----	-----	10	μA	Vr=5V



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■ Reliability Test Items And Conditions

NO	Item	Test Conditions	Test Hours/Cycle	Sample Size	Ac/Re
1	Solder Heat	TEMP : 260°C ± 5 °C	5 SEC	76 Pcs	0/1
2	Temperature Cycle	H : +85°C 30min ↓ 5 min L : -55°C 30min	50 CYCLE	76 Pcs	0/1
3	Thermal Shock	H : +100°C 5min ↓ 10 sec L : -10°C 5min	50 CYCLE	76 Pcs	0/1
4	High Temperature Storage	TEMP : 100°C	1000 HRS	76 Pcs	0/1
5	Low Temperature Storage	TEMP : -55°C	1000 HRS	76 Pcs	0/1
6	DC Operating Life	If = 20 mA	1000 HRS	76 Pcs	0/1
7	High Temperature / High Humidity	85°C/85% RH	1000 HRS	76 Pcs	0/1

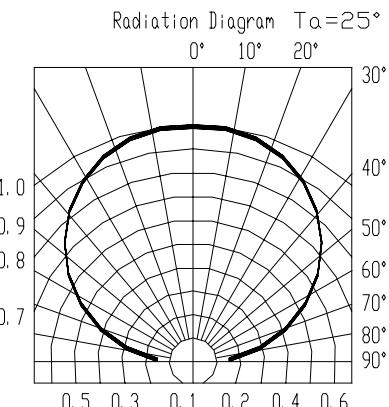
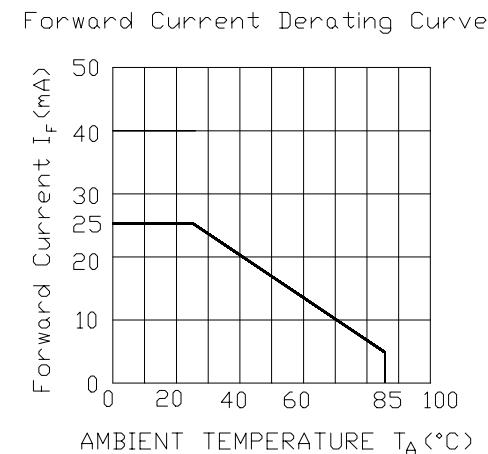
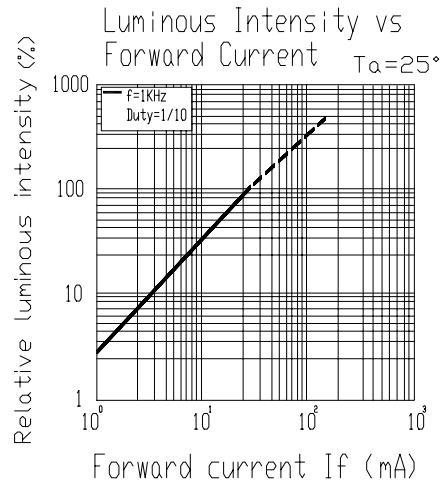
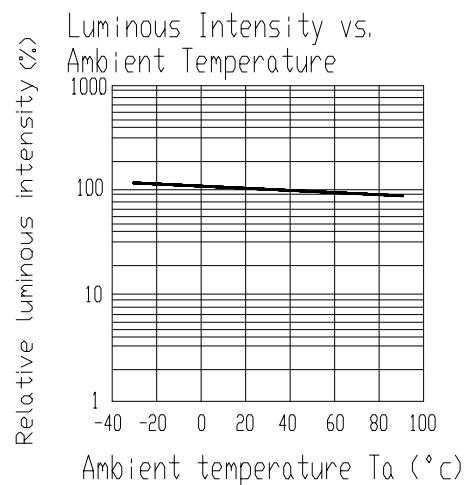
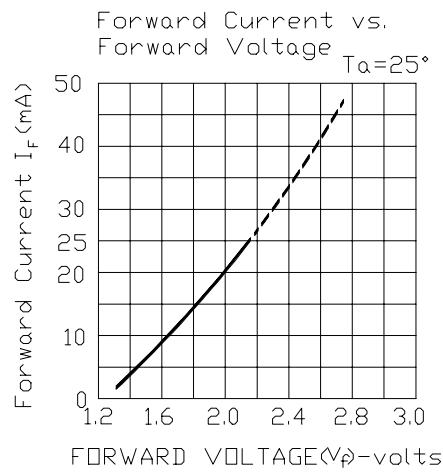
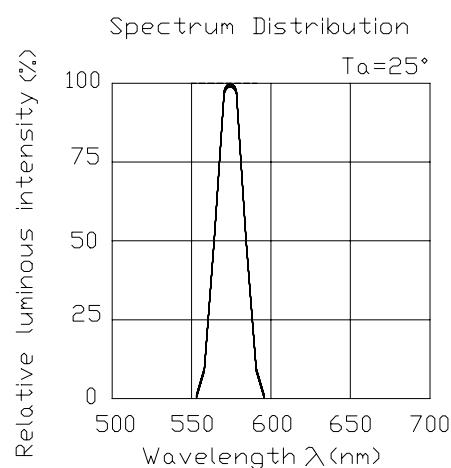
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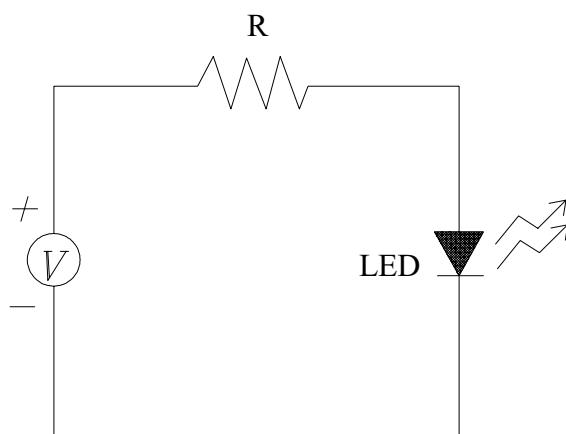
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Typical Electro-Optical Characteristic Curves

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Page: 6/8**■ Test Circuit****■ Precautions For Use****1. Over-current-proof**

Customer must apply resistors for protection , otherwise slight voltage shift will cause big current change (Burn out will happen).

2. Storage time

2.1 The operation of temperature and R.H. are : $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, R.H.60%.

2.2 Once the package is opened, the products should be used within a week.

Otherwise, they should be keeping in a damp proof box with desiccant agent.

Considering the tape life , we suggest our customers to use our products within a year(from production date).

2.3 If opened more than one week in an atmosphere $5^{\circ}\text{C} \sim 35^{\circ}\text{C}$, R.H.60%, they should be treated at $60^{\circ}\text{C} \pm 5^{\circ}\text{C}$ for 15hrs.

2.4 When you discover that the desiccant in the package has a pink color (Normal = blue), you should treat them in the same conditions as 2.3.

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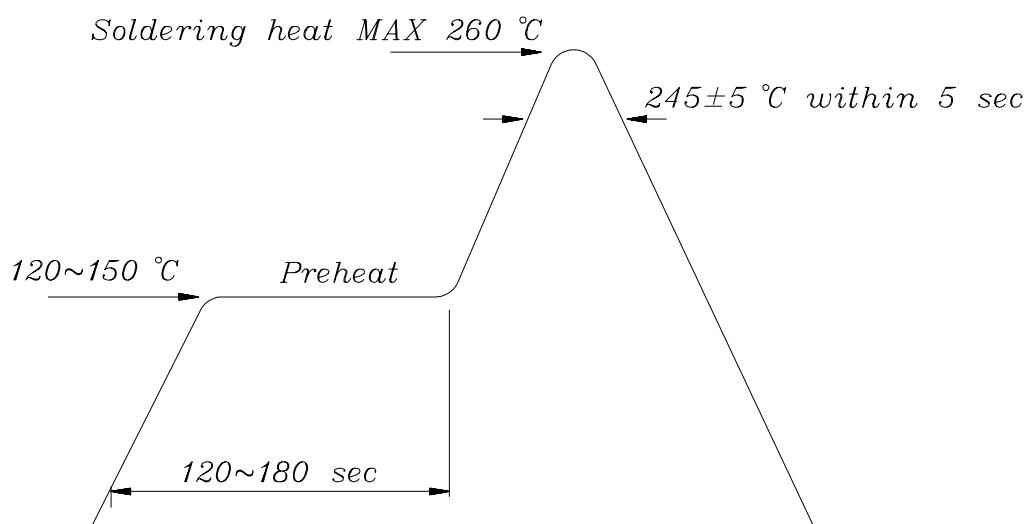
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■ Soldering heat reliability (DIP)

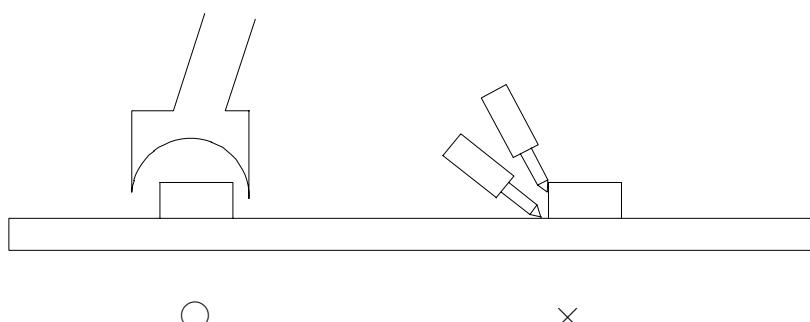
Please refer to the following figure :

**■ Soldering Iron**

Basic spec is ≤ 5 sec when 260°C . If temperature is higher, time should be shorter ($+10^{\circ}\text{C} \rightarrow -1\text{sec}$). Power dissipation of iron should be smaller than 15 W, and temperature should be controllable. Surface temperature of the device should be under 230°C .

■ Rework

1. Customer must finish rework within 5 sec under 260°C .
2. The head of iron can not touch copper foil.
3. Twin-head type is preferred.



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